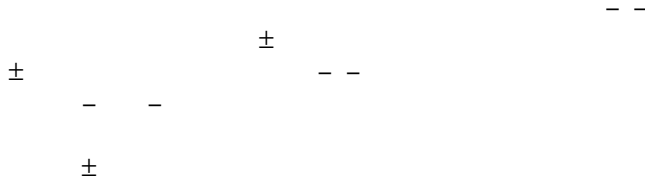


CM1205

ESD Protection Diode Array

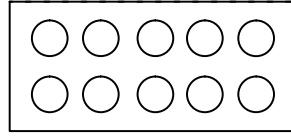
Chip Scale Package, 8-Channel

Description



CM1205

PACKAGE / PINOUT DIAGRAMS



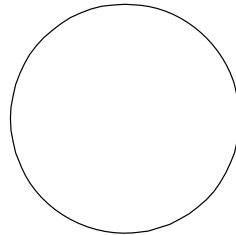
- -

CM1205

APPLICATION INFORMATION

Table 4. PRINTED CIRCUIT BOARD RECOMMENDATIONS

Parameter	Value
	-
	-
-	$\pm \mu$
	$\pm \mu$
	o

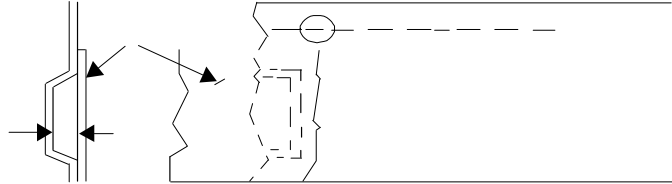


CM1205

MECHANICAL SPECIFICATIONS

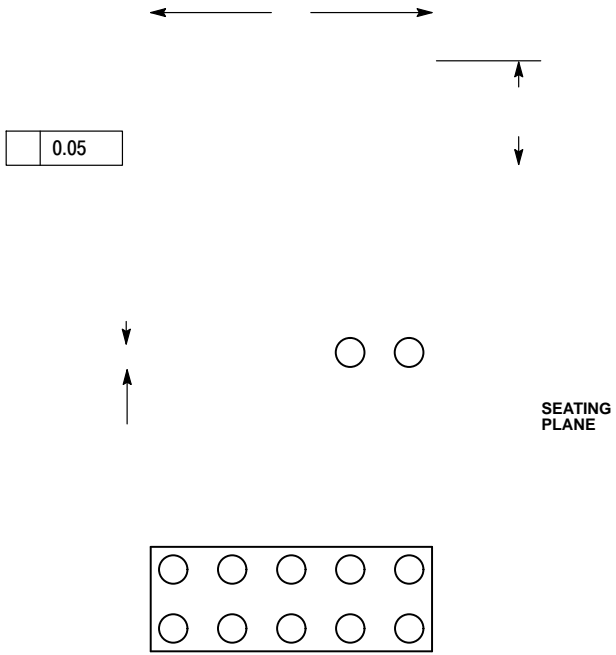
Table 5. CSP TAPE AND REEL SPECIFICATIONS

Part Number	Chip Size (mm)	Pocket Size (mm) $B_0 \times A_0 \times K_0$	Tape Width W	Reel Diameter	Qty per Reel	P_0	P_1
-				"			



WLCSP10, 3.10x1.15
CASE 567BM
ISSUE O

DATE 26 JUL 2010



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